

C0805C130M5HACTU

Aliases (C0805C130M5HAC7800)

SMD Comm X8R HT150C, Ceramic, 13 pF, 20%, 50 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0805



Click [here](#) for the 3D model.

| Dimensions | |
|------------|------------------|
| Chip Size | 0805 |
| L | 2mm +/-0.2mm |
| W | 1.25mm +/-0.2mm |
| T | 0.78mm +/-0.10mm |
| S | 0.75mm MIN |
| B | 0.5mm +/-0.25mm |

| Packaging Specifications | |
|--------------------------|------------------------|
| Packaging | T&R, 180mm, Paper Tape |
| Packaging Quantity | 4000 |

| General Information | |
|---------------------|---|
| Series | SMD Comm X8R HT150C |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Component Weight | 11 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Specifications | |
|--|---|
| Capacitance | 13 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Capacitance Tolerance | 20% |
| Voltage DC | 50 VDC |
| Dielectric Withstanding Voltage | 125 VDC |
| Temperature Range | -55/+150°C |
| Temperature Coefficient | X8R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1MegaHz 1.0Vrms |
| Dissipation Factor | 2.5% 1MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |